

BB178LX VHF variable capacitance diode Rev. 02 — 12 February 2009

Product data sheet

1. Product profile

1.1 General description

The BB178LX is a planar technology variable capacitance diode in a SOD882T ultra small leadless plastic SMD package. The excellent matching performance is achieved by gliding matching and a Direct Matching Assembly (DMA) procedure.

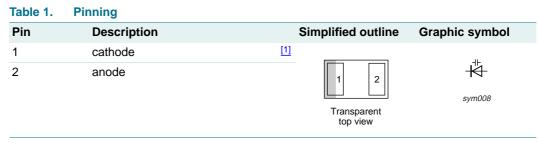
1.2 Features

- Excellent linearity
- Excellent matching to 2 % DMA
- Ultra small leadless SMD package
- C_{d(28V)}: 2.6 pF; $C_{d(1V)}$ to $C_{d(28V)}$ ratio typical 15
- Low series resistance

1.3 Applications

- Voltage Controlled Oscillators (VCO)
- Electronic tuning in VHF television tuners, Band B up to 460 MHz

2. Pinning information



[1] The marking bar indicates the cathode.

3. Ordering information

Table 2.Ordering information

Type number	Package				
	Name	Description	Version		
BB178LX	-	leadless ultra small plastic package; 2 terminals; body 1 \times 0.6 \times 0.4 mm	SOD882T		



4. Marking

Table 3.	Marking codes		
Type nun	nber	Marking code	
BB178LX		L3	

5. Limiting values

Table 4.	Limiting values
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In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Мах	Unit
V _R	reverse voltage		-	32	V
l _F	forward current		-	20	mA
T _{stg}	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

6. Characteristics

Table 5.Characteristics

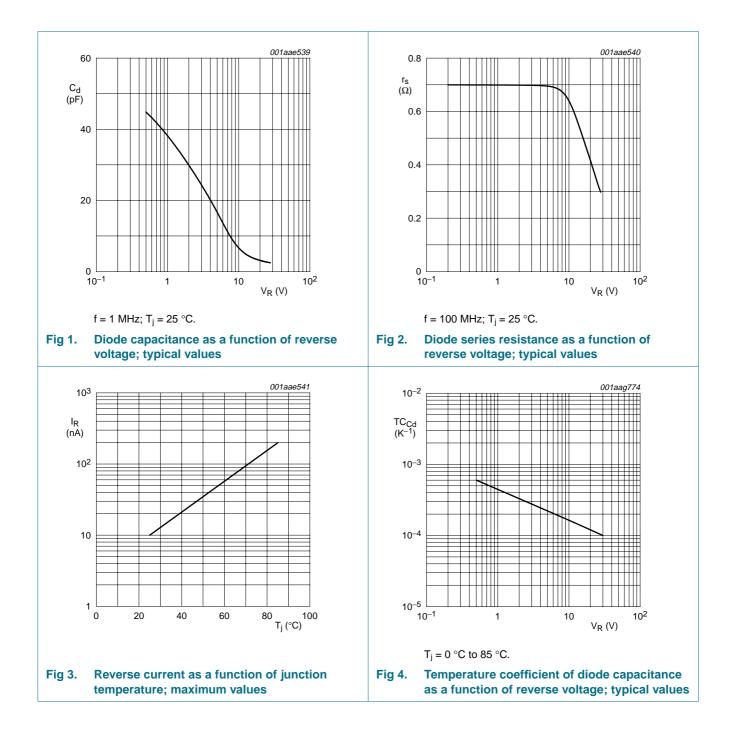
 $T_i = 25 \circ C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _R	reverse current	see Figure 3				
		V _R = 30 V	-	-	10	nA
		$V_R = 30$ V; $T_j = 85$ °C	-	-	200	nA
r _s	diode series resistance	f = 100 MHz at C _d = 30 pF; see <u>Figure 2</u>	-	0.7	-	Ω
C _d	diode capacitance	f = 1 MHz; see <u>Figure 1</u> and <u>Figure 4</u>				
		$V_R = 1 V$	34.65	-	42.35	pF
		V _R = 28 V	2.36	2.6	2.75	pF
C _{d(1V)} /C _{d(2V)}	diode capacitance ratio (1 V to 2 V)	f = 1 MHz	-	1.3	-	
C _{d(1V)} /C _{d(28V)}	diode capacitance ratio (1 V to 28 V)	f = 1 MHz	13.5	15	-	
C _{d(25V)} /C _{d(28V)}	diode capacitance ratio (25 V to 28 V)	f = 1 MHz	-	1.08	-	
$\Delta C_d / C_d$	diode capacitance matching	$V_R = 1 V$ to 28 V; in sequence of 5 diodes (gliding)	-	-	2	%

NXP Semiconductors

BB178LX

VHF variable capacitance diode



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7. Package outline

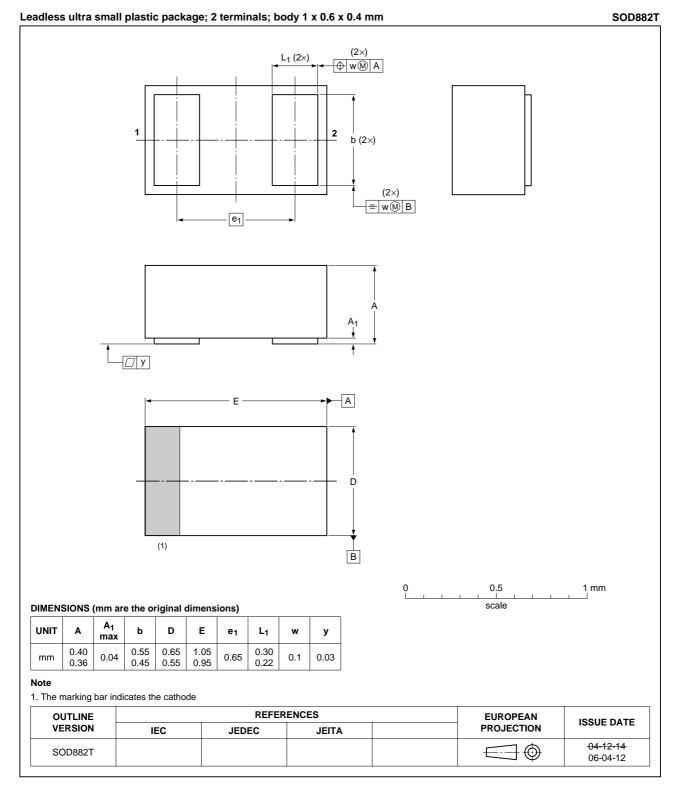


Fig 5. Package outline SOD882T

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8. Abbreviations

Table 6.	e 6. Abbreviations		
Acronym	Description		
SMD	Surface Mounted Device		
VHF	Very High Frequency		

9. Revision history

Table 7. Revision histo	ory				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
BB178LX_2	20090212	Product data sheet	-	BB178LX_1	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 				
	 Legal texts have been adapted to the new company name where appropriate. 				
	 Descriptive ti 	tle: 'UHF diode' changed to 'V	'HF diode'		
	• Table 5 "Cha	racteristics": r _s Condition 'f = 4	70 MHz' changed to	ʻf = 100 MHz'	
BB178LX_1	20060414	Preliminary data sheet	-	-	

10. Legal information

10.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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BB178LX

VHF variable capacitance diode

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